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Part Number:	075702000		
	0757830009		
Status:	Active		
Overview:	iPass Connector System		
Description:	iPass I/O Surface Mount Re	eceptacle, 0.80mm Pitch, Right-Angle, Internal Assembly	A A A A A A A A A A A A A A A A A A A
	with Shell, 26 Circuit, 0.38µ	Im Gold (Au), Retention-Fit Shell Option, Tail Length	
	1.96mm, Dual Key		
			-
Documents:			
3D Model		Product Specification PS-75783-001-001 (PDF)	
Drawing (PDF)		Packaging Specification PK-75783-002-001 (PDF)	- ๆ -
3D Model (PDF)		RoHS Certificate of Compliance (PDF)	Series image - Reference only
			-
Agency Certification			EU ELV
CSA		LR19980	Not Relevant
UL		E29179	
			EU RoHS China RoHS
General			Compliant
Product Family		I/O Connectors	REACH SVHC
Series		<u>75783</u>	Not Contained Per -
Application		Wire-to-Board	D(2021)4569-DC (8
Comments		Positive or passive latching cable available	July 2021)
Component Type		Receptacle	Halogen-Free
Electrical Model		Yes	Status
Overview		iPass Connector System	Low-Halogen
Product Name		iPass, Mini Multi-Lane, PCI Express	For more information, please visit Contact US
Туре		N/A	
UPC		822350092074	China ROHS Green Image
01.0		02200002011	ELV Not Relevant
Physical			RoHS Phthalates Not Contained
Circuits (Loaded)		26	
Circuits (maximum)		26	
Color - Resin		Black	
Durability (mating cycle	es max)	50	Search Parts in this Series
Flammability	,	94V-0	<u>75783</u> Series
Gender		Female	
Keying to Mating Part		Yes	Use With
Lock to Mating Part		None	iPass Cable Assemblies, <u>79575</u> , <u>79576</u> ,
Material - Metal		Copper-Nickel-Zinc, High Performance Alloy (HPA)	<u>74562</u> , <u>74563</u> , <u>79536</u> , <u>74573</u> ,
Material - Plating Matir	n	Gold	/ / <u></u> / <u></u> /
Material - Plating Term		Tin	
Material - Resin		High Temperature Thermoplastic	
Net Weight		2.558/g	
Number of Rows		2	
Orientation		Z Right Angle	
PC Tail Length		1.96mm	
PCB Locator		Yes	
PCB Retention		Yes	
PCB Retention PCB Thickness - Reco	mmended	1.57mm	
Packaging Type Panel Mount		Embossed Tape on Reel	
		No 0.80mm	
Pitch - Mating Interface		0.80mm	
Pitch - Termination Inte	errace	0.80mm	
Plating min - Mating		0.381µm	
Plating min - Terminati			
-		2.540µm	
Polarized to Mating Pa		2.540µm Yes	
-	rt	•	

Temperature Range - Operating Termination Interface: Style Waterproof / Dustproof Wire Insulation Diameter Wire Size AWG	-40° to +80°C Surface Mount No N/A N/A			
Electrical Current - Maximum per Contact Grounding to Panel Voltage - Maximum	0.5A None 30V AC (RMS)/DC			
Solder Process Data Duration at Max. Process Temperature (seconds) Lead-freeProcess Capability Max. Cycles at Max. Process Temperature Process Temperature max. C	020 REFLOW 001 260			
Material Info				
Reference - Drawing Numbers Electrical Model Document Packaging Specification Product Specification S-Parameter Model Sales Drawing	EE-75586-001-001 PK-75783-002-001 PS-75783-001-001 SP-75586-001-001 SD-75783-001-001			

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